## WHAT IS CLAIMED IS:

1. A magnetoresistive film comprising:

an antiferromagnetic layer;

a first pinned ferromagnetic layer superposed on the antiferromagnetic layer;

an antiferromagnetic bonding layer superposed on the first pinned ferromagnetic layer;

a second pinned ferromagnetic layer superposed on the antiferromagnetic bonding layer;

a non-magnetic spacer layer superposed on the second pinned ferromagnetic layer;

a free ferromagnetic layer superposed on the non-magnetic spacer layer; and

a compound existing between the antiferromagnetic layer and the second pinned ferromagnetic layer.

- 2. The magnetoresistive film according to claim 1, wherein said antiferromagnetic layer is a polycrystalline layer of a regulated lattice structure.
- 3. The magnetoresistive film according to claim 2, wherein said compound comprises at least one of an oxide, a nitride, a sulfide and a carbide.
- 4. The magnetoresistive film according to claim 3, wherein said oxide, nitride, sulfide or carbide is a compound consisting of an element included in the antiferromagnetic bonding layer, and oxygen, nitrogen, sulfur or carbon.
- 5. The magnetoresistive film according to claim 4, wherein said antiferromagnetic bonding layer has a thickness

in the range between 0.5nm and 0.9nm.

- 6. The magnetoresistive film according to claim 5, wherein said non-magnetic spacer layer has a thickness in the range between 1.9nm and 2.3nm.
- 7. A method of making a magnetoresistive film, comprising:

forming a material layer on a substrate, said material layer containing an antiferromagnetic metallic element;

forming a first pinned ferromagnetic layer on the material layer;

forming an antiferromagnetic bonding layer on the first pinned ferromagnetic layer;

transforming a part of the antiferromagnetic bonding layer so as to generate a transformed layer at a surface of the antiferromagnetic bonding layer;

forming a second pinned ferromagnetic layer on the antiferromagnetic bonding layer;

forming a non-magnetic spacer layer on the second pinned ferromagnetic layer;

forming a free ferromagnetic layer on the non-magnetic spacer layer; and

effecting a heat treatment on at least the material layer.

- 8. The method of making according to claim 7, wherein said transformed layer comprises at least a compound selected from a group consisting of an oxide, a nitride, a sulfide and a carbide.
  - 9. The method of making according to claim 7, wherein said

antiferromagnetic bonding layer is exposed to a reactive gas in forming the transformed layer.

- 10. The method of making according to claim 9, wherein said reactive gas consists of at least one of oxide and nitrogen.
  - 11. A layered polycrystalline structure film comprising; a first ferromagnetic crystal layer;

an antiferromagnetic bonding layer formed on the first ferromagnetic crystal layer based on epitaxy;

- a second ferromagnetic crystal layer formed on the epitaxial antiferromagnetic bonding layer based on epitaxy; and
- a compound existing between the antiferromagnetic bonding layer and the second ferromagnetic crystal layer.
- 12. The layered polycrystalline structure film according to claim 11, wherein said compound comprises at least one of an oxide, a nitride, a sulfide and a carbide.
- 13. The layered polycrystalline structure film according to claim 12, wherein said oxide, nitride, sulfide or carbide is a compound consisting of an element included in the antiferromagnetic bonding layer, and oxygen, nitrogen, sulfur or carbon.

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